



AEC-Q200
This component was always
RoHS compliant from the first
date of manufacture.

- *Designed for SDARS IF Receiver*
- *Low Insertion Loss*
- *5.0 x 5.0 mm Surface-mount Case*
- *Differential or Single-ended Input and Output*
- *Complies with Directive 2002/95/EC (RoHS)*

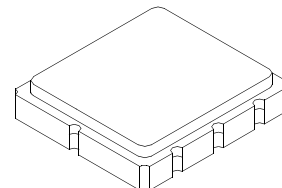


Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile	265°C for 10 s	

SF2038C

**76.500 MHz
SAW Filter**



SM5050-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C			76.500		MHz
Passband Insertion Loss	IL			10.8	12.0	dB
1 dB Bandwidth	BW ₁		12.0	12.7		MHz
15 dB Bandwidth	BW ₁₅			17.5	18.0	MHz
30 dB Bandwidth	BW ₃₀			19.4	20.0	MHz
Amplitude Ripple over $f_C \pm 6.0$ MHz				0.60	1.3	dB _{P-P}
Group Delay Variation over $f_C \pm 6.0$ MHz	GDV			40	150	ns _{P-P}
Rejection:						dB
50 to 64.44 MHz			36	42		
64.44 to 66.70 MHz			33	39		
86.30 to 87.06 MHz			16*	24		
87.06 to 91.50 MHz			23*	34		
91.50 to 100.000 MHz			36	40		
Operating Temperature Range	T _A		-40		+85	°C
Frequency Temperature Coefficient	FTC			-87		ppm/°C
Differential Input			175 ohms			
Differential Output			180 ohms			
Case Style			SM5050-8 5 x 5 mm Nominal Footprint			
Lid Symbolization (Y=year, WW=week, S=shift)			913, YWWS			

*At low temperature extreme -40 °C

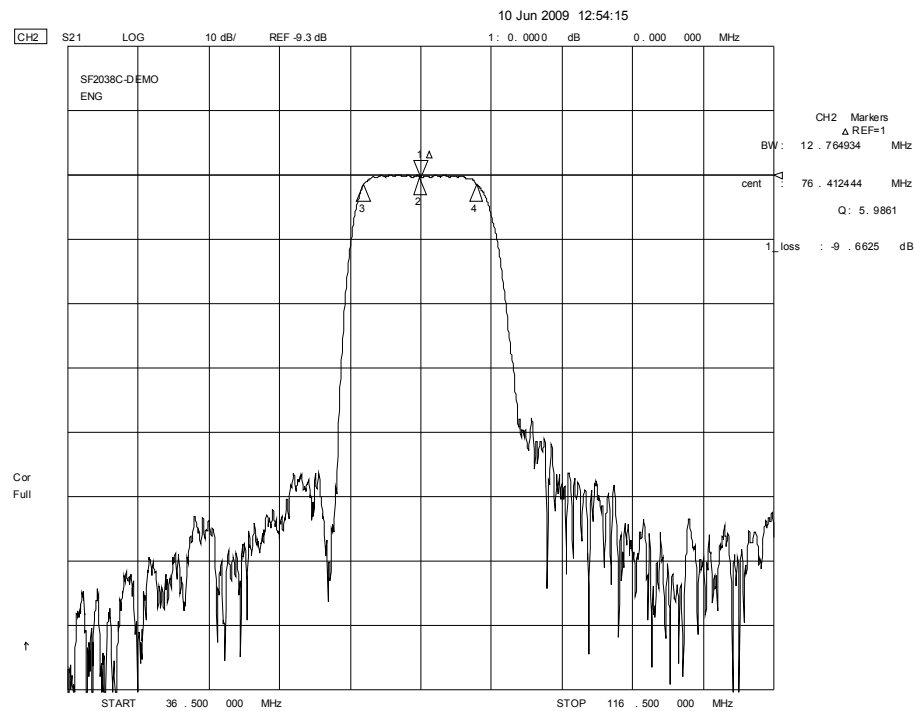


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

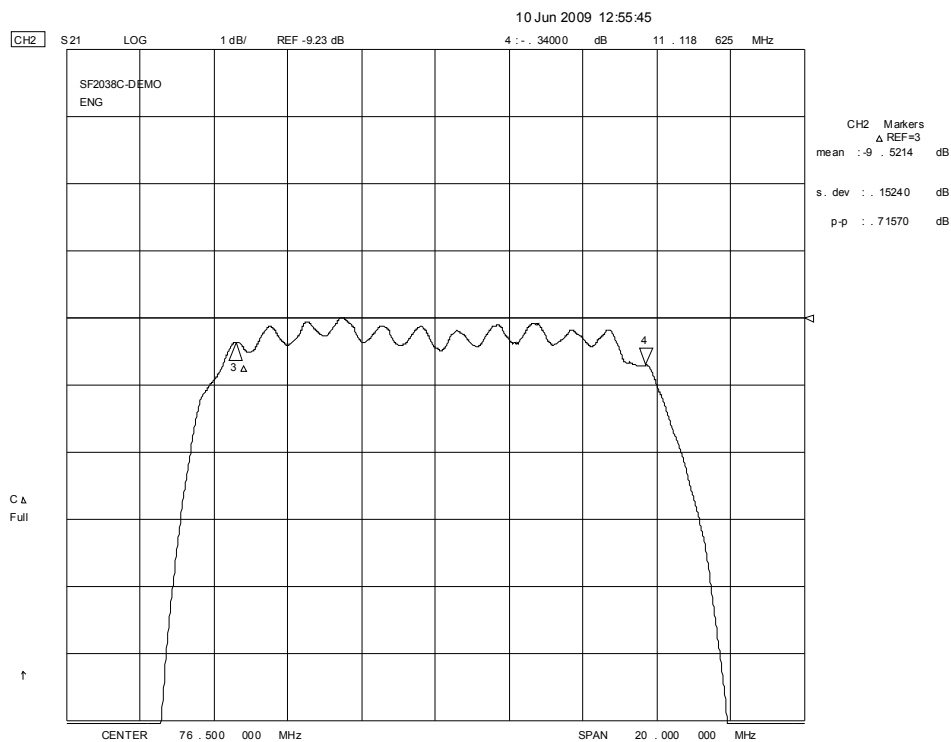
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

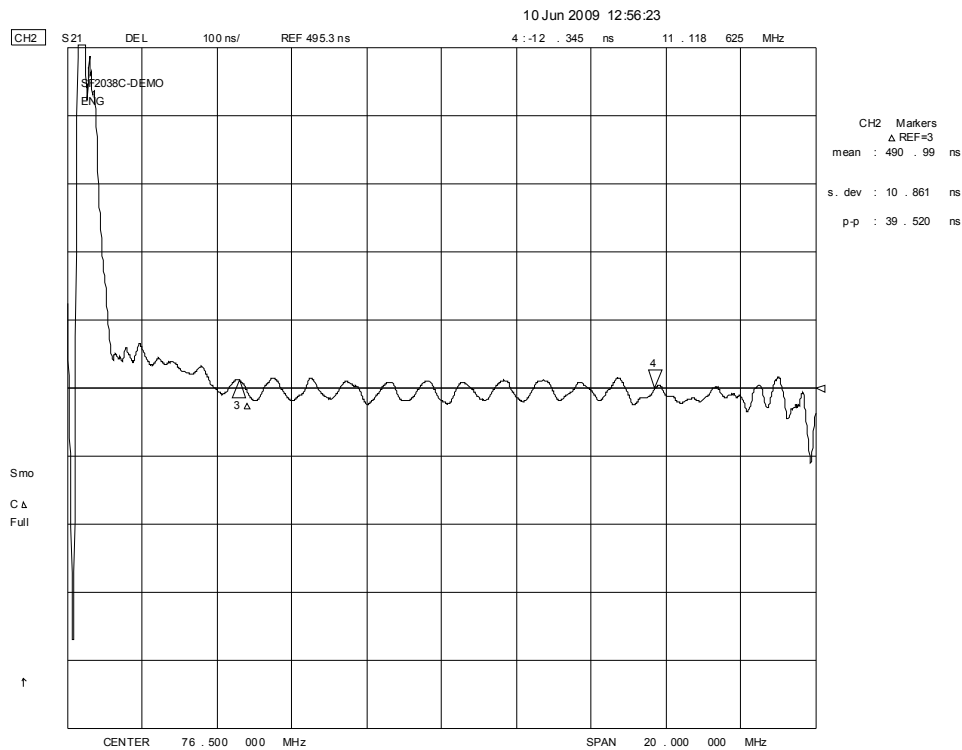
Filter Response, 36.5 to 116.5 MHz



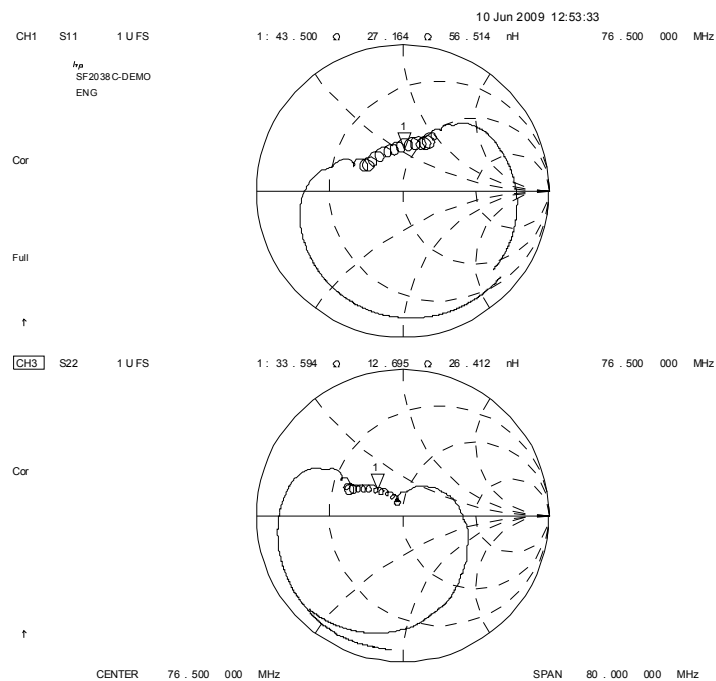
Filter Passband Response



Filter Passband Group Delay Response

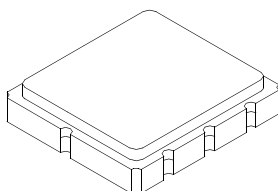


Filter S_{11} and S_{22} Plots

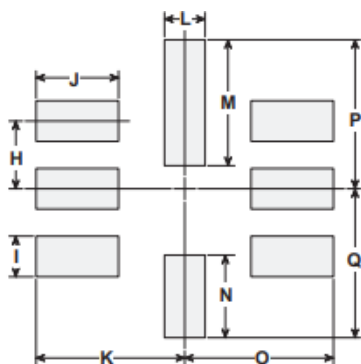


SM5050-8 Surface-Mount 8-Terminal Ceramic Case

5.0 X 5.0 mm Nominal Footprint



PCB Footprint



Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.80	5.00	5.20	0.189	0.197	0.205
B	4.80	5.00	5.20	0.189	0.197	0.205
C	1.30	1.50	1.70	0.050	0.060	0.067
D	1.98	2.08	2.18	0.078	0.082	0.086
E	1.07	1.17	1.27	0.042	0.046	0.050
F	0.50	0.64	0.70	0.020	0.025	0.028
G	2.39	2.54	2.69	0.094	0.100	0.106
H		1.27			0.050	
I		0.76			0.030	
J		1.55			0.061	
K		2.79			0.110	
L		0.76			0.030	
M		2.36			0.093	
N		1.55			0.061	
O		2.79			0.110	
P		2.79			0.110	
Q		2.79			0.110	

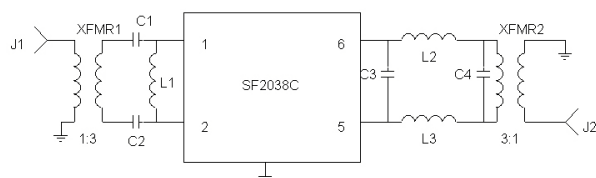
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic
Pb Free	

Electrical Connections

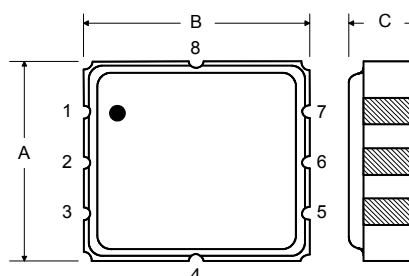
Connection	Terminals
Port 1	Differential Input
Port 2	Differential Output
	Ground
Single-ended Operation	Return is ground
Differential Operation	Return is hot
Dot indicates Pin 1	

Test Circuit

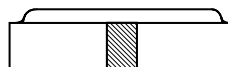
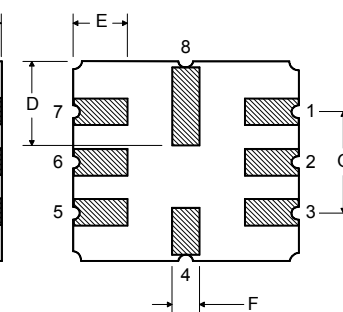


- L1 330 nH
- L2, L3 270 nH
- C1, C4 18 pF
- C2 15 pF
- C3 1 pF
- XFMR1, XFMR 2 3:1
- XFMR1, XFMR 2 3:1

TOP VIEW

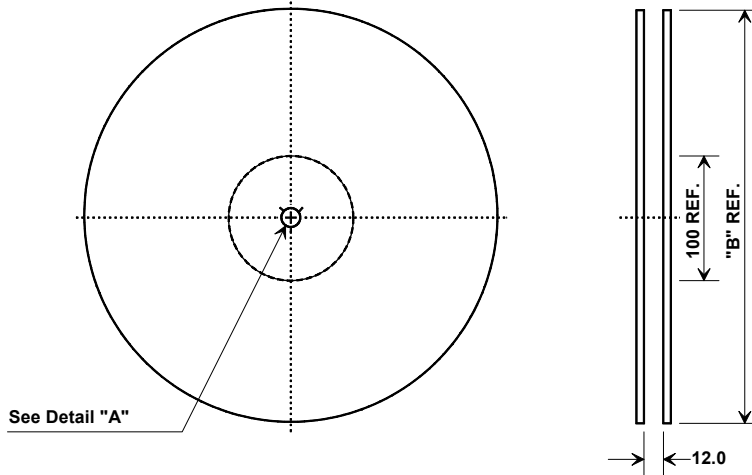


BOTTOM VIEW

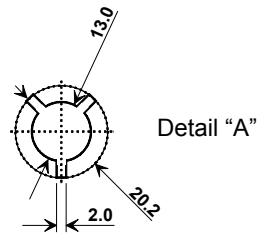


Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

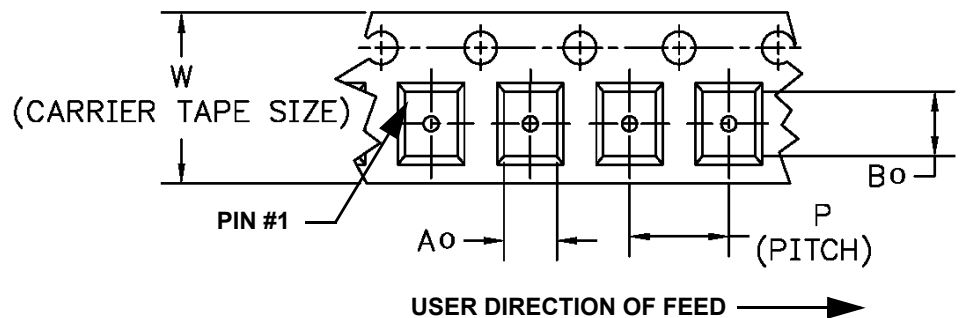
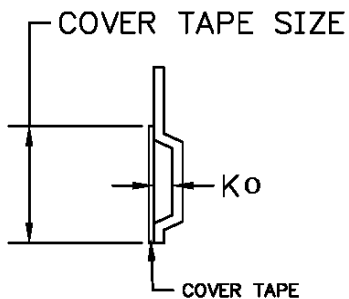


"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



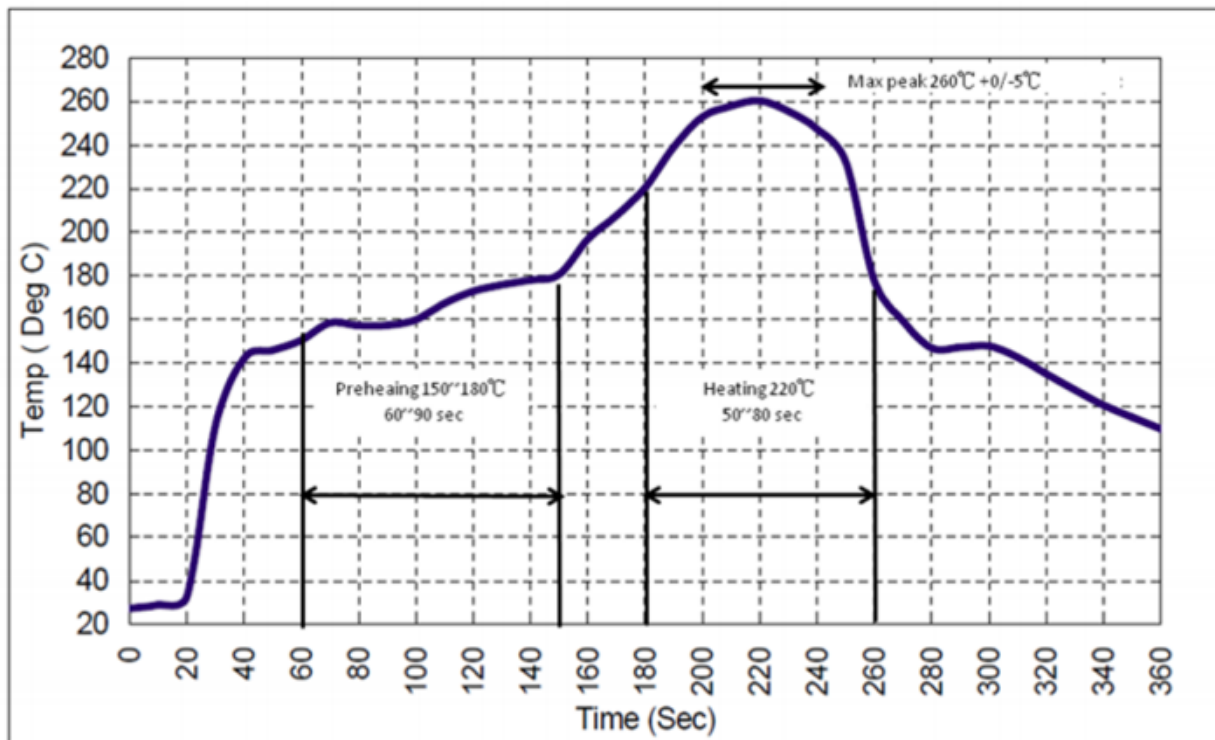
COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.3 mm
Bo	5.3 mm
Ko	2.0 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
4. Time: 5 times maximum.



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